| Application Serial No                 | 10/642,454                           |
|---------------------------------------|--------------------------------------|
| Filing Date                           |                                      |
| Inventor                              |                                      |
| Assignee                              |                                      |
| Group Art Unit                        | 2811                                 |
| Examiner                              |                                      |
| Attorney's Docket No                  | MI22-2382                            |
| Title: Platinum-Containing Integrated | Circuits and Capacitor Constructions |

## TERMINAL DISCLAIMER

I, Robert C. Hyta, residing at Spokane, Washington, represent that I am the attorney of record for Wells St. John, P.S., a corporation of the State of Washington. Micron Technology, Inc. is the owner of all right, title and interest of this U.S. Patent Application Serial No. 10/642,454, filed August 13, 2003, as evidenced by an assignment recorded August 27, 1998, at Reel 9413, Frames 0969-0974 in the U.S. Patent and Trademark Office.

Micron Technology, Inc. is also the owner of all right, title and interest in U.S. Patent No. 5,990,559 as evidenced by an assignment recorded August 27, 1998, at Reel 9413, Frames 0969-0974, in the U.S. Patent and Trademark Office.

The evidentiary documents have been reviewed, and I certify that, to the best of assignee's knowledge and belief, title is in the assignee seeking to take this action.

Micron Technology, Inc. hereby disclaims the terminal part of any future patent granted on this U.S. Patent Application Serial No. 10/642,454 which extends beyond the expiration date of U.S. Patent No. 5,990,559 and further hereby agrees that any future patent so granted on this U.S. Patent Application

Serial No. 10/642,454 shall be enforceable only for and during such period that the legal title on the U.S. Patent No. 5,990,559 shall be the same as the legal title to any patent issued from U.S. Patent Application No. 10/642,454. This agreement is to run with any patent granted on the 10/642,454 application and is to be binding upon the grantee of such patent and its successors or assigns.

Micron Technology, Inc. does not disclaim any terminal part of any patent granted on this 10/642,454 application prior to the expiration date of the full statutory term of the U.S. Patent No. 5,990,559 in the event that it later: expires for failure to pay a maintenance fee, is held unenforceable, is found invalid by a court of competent jurisdiction, is statutorily disclaimed in whole or terminally disclaimed under 37 C.F.R. §1.321(a), has all claims canceled by a reexamination certificate, is reissued in any manner or is otherwise terminated prior to expiration of its full statutory term as presently shortened by any terminal disclaimer, except for the separation of legal title stated above.

The fee required by 37 C.F.R. 1.20(d) is submitted herewith. The Commissioner is hereby authorized to charge payment of any additional fees or credit overpayments to Deposit Account No. 23-0925.

The undersigned, Robert C. Hyta, hereby indicates that he is authorized to sign this document on behalf of the assignee, Micron Technology, Inc.

Respectfully submitted,

Datod:

Bv:

Robert C. Hyta Reg. No. 46,791